

M1AFS250-2FGG256

M1AFS250-2FGG256 Information

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	Manufacturer	Microsemi Corporation	_
	Category	Integrated Circuits (ICs) Embedded - FPGAs (Field Programmable Gate Array)	影
	Description	IC FPGA 114 I/O 256FBGA	月日
	Package	256-LBGA	
For Reference Only		For the pricing/inventory/lead time, please contact us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Req

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



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M1AFS250-2FGG256 Specifications

Manufacturer Part Number	M1AFS250-2FGG256
Manufacturer	Microsemi Corporation
Category	Integrated Circuits (ICs)
	Embedded - FPGAs (Field Programmable Gate Array)
Package	256-LBGA
Series	Fusion?
Number of LABs/CLBs	-
Number of Logic Elements/Cells	-
Total RAM Bits	36864
Number of I/O	114
Number of Gates	250000
Voltage - Supply	1.425 V ~ 1.575 V
Mounting Type	Surface Mount
Operating Temperature	0° C ~ 85° C (TJ)
Package / Case	256-LBGA
Supplier Device Package	256-FPBGA (17x17)
	Report errors?

M1AFS250-2FGG256 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

M1AFS250-2FGG256 Payment Methods



If you have any question about M1AFS250-2FGG256, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com